

Freescale Semiconductor

Technical Data

MC144110/D Rev. 2, 1/2005

MC144110 and MC144111

Digital-to-Analog Converters with Serial Interface CMOS LSI

1 Introduction

The MC144110 and MC144111 are low-cost 6-bit D/A converters with serial interface ports to provide communication with CMOS microprocessors and microcomputers. The MC144110 contains six static D/A converters; the MC144111 contains four converters.

Due to a unique feature of these DACs, the user is permitted easy scaling of the analog outputs of a system. Over a 5 to 15 V supply range, these DACs may be directly interfaced to CMOS MPUs operating at 5 V.

- Direct R-2R Network Outputs
- Buffered Emitter-Follower Outputs
- Serial Data Input

products.

- Digital Data Output Facilitates Cascading
- Direct Interface to CMOS µP
- Wide Operating Voltage Range: 4.5 to 15 V

© Freescale Semiconductor, Inc., 2005. All rights reserved.

- Wide Operating Temperature Range: 0 to 85°C
- Software Information is Contained in Document M68HC11RM/AD

MC144110





Package Information P Suffix Plastic DIP Case 707 Package Information DW Suffix SOG Package Case 751D

MC144111





Package Information P Suffix Plastic DIP Case 646 Package Information DW Suffix SOG Package Case 751G

Ordering Information

Device	Package
MC144110P	Plastic DIP
MC144110DW	SOG
MC144111P	Plastic DIP
MC144111DW	SOG

Contents

Freescale reserves the right to change the detail specifications as may be required to permit improvements in the design of its

- 1 Introduction 1
- 2 Electrical Specifications 4
- 3 Switching Characteristics 5
- 4 Pin Descriptions...... 8
- 5 Packaging 10





Introduction



Figure 1. Block Diagram

Introduction



MC144110P

D _{in}	1•	18	V _{DD}
Q1 Out	2	17	D _{out}
R1 Out	3	16	R6 Out
Q2 Out	4	15	Q6 Out
R2 Out	5	14	R5 Out
Q3 Out	6	13	Q5 Out
R3 Out	7	12	R4 Out
ENB	8	11	Q4 Out
V _{SS}	9	10	CLK

MC144110DW				
D _{in}	C	1•	20	V _{DD}
Q1 Out	C	2	19	D _{out}
R1 Out	C	3	18	R6 Out
Q2 Out	۵	4	17	Q6 Out
R2 Out	C	5	16	R5 Out
Q3 Out	C	6	15	Q5 Out

Q3 Out	Ę	6	15	Q5 Out
R3 Out	C	7	14	R4 Out
ENB	C	8	13	Q4 Out
V_{SS}	C	9	12	CLK
NC	Ę	10	11	NC

MC144111P

D _{in}	1 •	14	V _{DD}
Q1 Out		13	D _{out}
R1 Out	3	12	R4 Out
Q2 Out	4	11	Q4 Out
R2 Out	5	10	R3 Out
ENB	6	9	Q3 Out
V _{SS}	7	8	CLK

MC144111DW

D _{in}	1•	16	V _{DD}
Q1 Out	2	15	D _{out}
R1 Out	3	14	R4 Out
Q2 Out	4	13	Q4 Out
R2 Out	5	12	R3 Out
ENB	6	11	Q3 Out
V _{SS}	7	10] CLK
C	8	9	NC

NC = No Connection

Figure 2. Pin Assignments



Electrical Specifications

2 Electrical Specifications

Table 1. Maximum Ratings

(Voltages	referenced	to	V _{SS})
-----------	------------	----	-------------------

	Ratings		Value	Unit
DC Supply Volt	age	V _{DD}	- 0.5 to + 18	V
Input Voltage, A	All Inputs	V _{in}	- 0.5 to V _{DD} + 0.5	V
DC Input Curre	nt, per Pin	I	± 10	mA
Power Dissipat $T_A = 70^{\circ}C$ $T_A = 85^{\circ}C$	ion (Per Output) MC144110 MC144111 MC144110 MC144111	P _{OH}	30 50 10 20	mW
	ion (Per Package) MC144110 MC144111 MC144110 MC144111	PD	100 150 25 50	mW
Storage Tempe	rature Range	T _{stg}	- 65 to + 150	°C

This device contains protection circuitry to guard against damage due to high static voltages or electric fields; however, it is advised that precautions be taken to avoid application of voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation it is recommended that V_{in} and V_{out} be constrained to the range $V_{SS} \leq (V_{in} \text{ or } V_{out}) \leq V_{DD}$.

Unused inputs must always be tied to an appropriate logic voltage level (e.g., either V_{SS} or V_{DD}).

Table 2. Electrical Characteristics

(Voltages referenced to V_{SS} , $T_A = 0$ to $85^{\circ}C$ unless otherwise indicated)

Symbol	Parameter	Test Conditions	V _{DD}	Min	Max	Unit
V _{IH}	High-Level Input Voltage (D _{in} , ENB, CLK)		5 10 15	3.0 3.5 4	- - -	V
V _{IL}	Low-Level Input Voltage (D _{in} , ENB, CLK)		5 10 15	- - -	0.8 0.8 0.8	V
I _{OH}	High-Level Output Current (D _{out})	$V_{out} = V_{DD} - 0.5 V$	5	- 200	-	μA
I _{OL}	Low-Level Output Current (D _{out})	$V_{out} = 0.5 V$	5	200	-	μA
I _{DD}	Quiescent Supply Current MC144110 MC144111	$I_{out} = 0 \ \mu A$	15 15	-	12 8	mA
l _{in}	Input Leakage Current (D _{in} , ENB, CLK)	$V_{in} = V_{DD} \text{ or } 0 \text{ V}$	15	-	± 1	μA
V _{nonl}	Nonlinearity Voltage (Rn Out)	See Figure 3	5 10 15	- - -	100 200 300	mV



Switching Characteristics

Table 2. Electrical Characteristics (continued)

Symbol	Parameter	Test Conditions	V_{DD}	Min	Max	Unit
V _{step}	Step Size (Rn Out)	See Figure 4	5 10 15	19 39 58	137 274 411	mV
V _{offset}	Offset Voltage from V _{SS}	D _{in} = \$00, See Figure 3	-	-	1	LSB
Ι _Ε	Emitter Leakage Current	V _{Rn Out} = 0 V	15	-	10	μA
h _{FE}	DC Current Gain	$I_E = 0.1$ to 10.0 mA $T_A = 25^{\circ}C$	-	40	-	-
V_{BE}	Base-to-Emitter Voltage Drop	I _E = 1.0 mA	-	0.4	0.7	V

(Voltages referenced to V_{SS} , $T_A = 0$ to 85°C unless otherwise indicated)

3 Switching Characteristics

Table 3. Switching Characteristics

(Voltages referenced to V_{SS}, $T_A = 0$ to 85°C, $C_L = 50$ pF, Input $t_r = t_f = 20$ ns unless otherwise indicated)

Symbol	Parameter	V _{DD}	Min	Мах	Unit
t _{wH}	Positive Pulse Width, CLK (Figures 5 and 6)	5	2	-	μS
		10	1.5	-	
		15	1	-	
t _{wL}	Negative Pulse Width, CLK (Figure 5 and 6)	5	5	-	μS
		10	3.5	-	
		15	2	-	
t _{su}	Setup Time, ENB to CLK (Figures 5 and 6)	5	5	-	μS
		10	3.5	-	
		15	2	-	
t _{su}	Setup Time, D _{in} to CLK (Figures 5 and 6)	5	1000	-	ns
04		10	750	-	
		15	500	-	
t _h	Hold Time, CLK to ENB (Figures 5 and 6)	5	5	-	μS
		10	3.5	-	
		15	2	-	
t _h	Hold Time, CLK to D _{in} (Figures 5 and 6)	5	5	-	μS
		10	3.5	-	
		15	2	-	
t _r , t _f	Input Rise and Fall Times	5 - 15	-	2	μs
C _{in}	Input Capacitance	5 - 15	-	7.5	pF



Switching Characteristics









Figure 4. Definition of Step Size



Switching Characteristics







Figure 6. Serial Input, Negative Clock

Table 4. Number o	f Channels vs	Clocks Required
-------------------	---------------	------------------------

Number of Channels Required	Number of Clock Cycles	Outputs Used on MC144110	Outputs Used on MC144111	
1	6	Q1/R1	Q1/R1	
2	12	Q1/R1, Q2/R2	Q1/R1, Q2/R2	
3	18	Q1/R1, Q2/R2, Q3/R3	Q1/R1, Q2/R2, Q3/R3	
4	24	Q1/R1, Q2/R2, Q3/R3, Q4/R4	Q1/R1, Q2/R2, Q3/R3, Q4/R4	
5	30	Q1/R1, Q2/R2, Q3/R3, Q4/R4, Q5/R5	Not Applicable	
6	36	Q1/R1, Q2/R2, Q3/R3, Q4/R4, Q5/R5, Q6/R6	Not Applicable	



Pin Descriptions

4 Pin Descriptions

4.1 INPUTS

D_{in} Data Input

Six-bit words are entered serially, MSB first, into digital data input, D_{in}. Six words are loaded into the MC144110 during each D/A cycle; four words are loaded into the MC144111.

The last 6-bit word shifted in determines the output level of pins Q1 Out and R1 Out. The next-to-last 6-bit word affects pins Q2 Out and R2 Out, etc.

ENB

Negative Logic Enable

The $\overline{\text{ENB}}$ pin must be low (active) during the serial load. On the low-to-high transition of $\overline{\text{ENB}}$, data contained in the shift register is loaded into the latch.

CLK Shift Register Clock

Data is shifted into the register on the high-to-low transition of CLK. CLK is fed into the D-input of a transparent latch, which is used for inhibiting the clocking of the shift register when $\overline{\text{ENB}}$ is high.

The number of clock cycles required for the MC144110 is usually 36. The MC144111 usually uses 24 cycles. See Table 4 for additional information.

4.2 OUTPUTS

D_{out} Data Output

The digital data output is primarily used for cascading the DACs and may be fed into D_{in} of the next stage.

R1 Out through Rn Out Resistor Network Outputs

These are the R-2R resistor network outputs. These outputs may be fed to high-impedance input FET op amps to bypass the on-chip bipolar transistors. The R value of the resistor network ranges from 7 to 15 k Ω .

MC144110 Technical Data, Rev. 2



Q1 Out through Qn Out NPN Transistor Outputs

Buffered DAC outputs utilize an emitter-follower configuration for current-gain, thereby allowing interface to low-impedance circuits.

4.3 SUPPLY PINS

V_{SS} Negative Supply Voltage

This pin is usually ground.

V_{DD} Positive Supply Voltage

The voltage applied to this pin is used to scale the analog output swing from 4.5 to 15 V p-p.



Packaging

5 Packaging



NOTES:

1. POSITIONAL TOLERANCE OF LEADS (D). SHALL BE WITHIN 0.25 (0.010) AT MAXIMUM MATERIAL CONDITION, IN RELATION TO SEATING PLANE AND EACH OTHER.

2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.

3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

^{4.} CONTROLLING DIMENSION: INCH.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
Α	0.875	0.915	22.22	23.24
В	0.240	0.260	6.10	6.60
С	0.140	0.180	3.56	4.57
D	0.014	0.022	0.36	0.56
F	0.050	0.070	1.27	1.78
G	0.100 BSC		2.54 BSC	
Н	0.040	0.060	1.02	1.52
J	0.008	0.012	0.20	0.30
Κ	0.115	0.135	2.92	3.43
L	0.300 BSC		7.62 BSC	
Μ	0°	15°	0°	15°
Ν	0.020	0.040	0.51	1.02







MC144110 Technical Data, Rev. 2



Packaging



Figure 9. Outline Dimensions for P SUFFIX, PLASTIC DIP (CASE 646-07, Issue P)



DTES:

- DIMENSIONS ARE IN MILLIMETERS.
 DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
- 3. DATUMS A AND B TO BE DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.
- ATHS DIMENSION DOES NOT INCLUDE MOLD FLASH, PROTRUSION OR GATE BURRS. MOLD FLASH, PROTRUSION OR GATE BURRS. MOLD FLASH, PROTRUSION OR GATE BURRS SHALL NOT EXCEED 0.15mm PER SIDE. THIS DIMENSION IS DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY. S, THIS DIMENSION DOES NOT INCLUDE
- THIS DIMENSION DOES NOT INCLUDE INTER-LEAD FLASH OR PROTRUSIONS. INTER-LEAD FLASH AND PROTRUSIONS SHALL NOT EXCEED 0.25mm PER SIDE. THIS DIMENSION IS DETERMINED AT THE PLANE WHERE THE BOTTOM OF THE LEADS EXIT THE PLASTIC BODY.

6 THIS DIMENSION DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL NOT CAUSE THE LEAD WIDTH TO EXCEED 0.62mm.





How to Reach Us:

Home Page: www.freescale.com

E-mail: support@freescale.com

USA/Europe or Locations Not Listed:

Freescale Semiconductor Technical Information Center, CH370 1300 N. Alma School Road Chandler, Arizona 85224 +1-800-521-6274 or +1-480-768-2130 support@freescale.com

Europe, Middle East, and Africa:

Freescale Halbleiter Deutschland GmbH Technical Information Center Schatzbogen 7 81829 Muenchen, Germany +44 1296 380 456 (English) +46 8 52200080 (English) +49 89 92103 559 (German) +33 1 69 35 48 48 (French) support@freescale.com

Japan:

Freescale Semiconductor Japan Ltd. Headquarters ARCO Tower 15F 1-8-1, Shimo-Meguro, Meguro-ku, Tokyo 153-0064 Japan 0120 191014 or +81 3 5437 9125 support.japan@freescale.com

Asia/Pacific:

Freescale Semiconductor Hong Kong Ltd. Technical Information Center 2 Dai King Street Tai Po Industrial Estate Tai Po, N.T., Hong Kong +800 2666 8080 support.asia@freescale.com

For Literature Requests Only:

Freescale Semiconductor Literature Distribution Center P.O. Box 5405 Denver, Colorado 80217 1-800-441-2447 or 303-675-2140 Fax: 303-675-2150 LDCForFreescaleSemiconductor@hibbertgroup.com RoHS-compliant and/or Pb- free versions of Freescale products have the functionality and electrical characteristics of their non-RoHS-compliant and/or non-Pb- free counterparts. For further information, see http://www.freescale.com or contact your Freescale sales representative.

For information on Freescale.s Environmental Products program, go to http://www.freescale.com/epp.

Information in this document is provided solely to enable system and software implementers to use Freescale Semiconductor products. There are no express or implied copyright licenses granted hereunder to design or fabricate any integrated circuits or integrated circuits based on the information in this document.

Freescale Semiconductor reserves the right to make changes without further notice to any products herein. Freescale Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does Freescale Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation consequential or incidental damages. "Typical" parameters that may be provided in Freescale Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals", must be validated for each customer application by customer's technical experts. Freescale Semiconductor does not convey any license under its patent rights nor the rights of others. Freescale Semiconductor products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the Freescale Semiconductor product could create a situation where personal injury or death may occur. Should Buyer purchase or use Freescale Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold Freescale Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that Freescale Semiconductor was negligent regarding the design or manufacture of the part.

Freescale[™] and the Freescale logo are trademarks of Freescale Semiconductor, Inc. All other product or service names are the property of their respective owners. © Freescale Semiconductor, Inc. 2005. All rights reserved.



MC144110/D Rev. 2 1/2005